



## **Product Specification**

TUDI-MAX1487

Low-Power, Slew-Rate-LimitedRS-485/RS-422 Transceivers

网址 www.sztdbdt.com Q

## 用芯智造·卓越品质

semiconductor device manufacturer

- Design
- research and development
- production
- and sales



#### **FEATURES**

- Thermal shutdown protection;
- ●Low-Current Shutdown Mode;
- ●True Fail-Safe Receiver;
- Excellent noise immunity;
- ■2.5Mbps in Electrically NoisyEnvironments;
- Hot-Swap Input Structures on DE and/RE;
- ●5V Power Supply, Half-duplex;
- allows up to 32transceivers on the bus;
- Short-circuit protection;

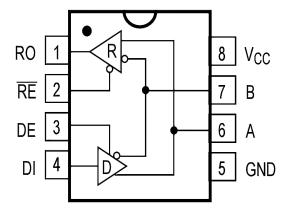


Figure 1. Pin Diagram

### Description

1487 operates under the supply voltage of 4.75V to 5.25V, 1487 is a true fail-safetransceiver. 1487 also has the function of thermal shutdown protection, current limitingprotection, overvoltage protection. DE and /RE control port input features such as hot-swappable. 1487 allows up to 32 transceivers on the bus,

The 1487 features reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission up to 2.5 Mbps. 1487 is a 5V power supply, half-duplex, low power, high speed RS485/RS422 Transceiver. 1487 Fully meets the TIA/EIA-485 standard.

1487 includes a driver and a receiver, both of which can be independently enabled and disabled. When both are disabled, the driver and receiver outputs are high-impedance state.

#### **FUNCTION TABLES**

TRANSMITTING						RECEIVING			
CTD	/RE	x	Х	0	1	0	0	0	1
CTR	DE	1	1	0	0	х	Х	Х	Х
	DI	1	0	Х	х				
INPUTS	A-B					≥-10mV	≤-200mV	Open/shorted	х
	А	Н	L	Z					
OUTPUTS	В	L	Н	Z					
	RO					Н	L	Н	Z
X:Don't care;Z:high impedance.									



## Pin description

Pin Number	Pin Name	FUNCTION
1	RO	Receiver Output.When enabled,ifA-B≥-10mV,then RO=high.IfA-B ≤-200 mV,then RO=low
2	/RE	Receiver Output Enable.Alow level enables the RO;a high level places it in a high impedance state.
3	DE	Driver Output Enable.A high level enables the driver differential outputs,Pin A and Pin B;a low level places the driver in a high impedance state.
4	DI	Driver Input.When the driver is enabled, a logic low on DI forces Pin A low and Pin B high; a logic high on DI forces PinA high and Pin B low.
5	GND	Ground Connection (0V).
6	А	No inverting Receiver Input A/Driver Output A
7	В	Inverting Receiver Input B/Driver Output B.
8	VCC	Power Supply

## Parameter limit

PARAMETER	Symbol	Value	Unit
CTR Port	/RE,DE,DI	-0.3~VCC+0.3	V
Driver Output Voltage	A、B	-7~13	V
Receiver Output Voltage	RO	-0.3~VCC+0.3	V
Supply Voltage	VCC	+7	V
Continuous Power Dissipation	MSOP8.SOP8.DIP8	830	mW
Soldering Temperature (reflow)		300	°C
Storage Temperature Range		-60~150	°C
Temperature Range		-40~85	°C

Stresses beyond those listed under "Parameter limit" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
	SW	/ITCHING CHARACTERISTIC	S OF RECEIVER			
Receiver Enable to Output Low	tRZL	CL=100 pF, S1closed		20	50	ns
Receiver Enable to Output High	tRZH	CL=100 pF, S2 closed		20	50	ns
Receiver Disable Time from Low	tRLZ	CL=100 pF,		20	50	ns
Receiver Disable Time from High	tRHZ	CL=100pF, S2 closed		20	50	ns
Receiver Propagation Delay (low to high)	tRPLH	Fig 7 and 8		50	200	ns
Receiver Propagation Delay (high to low)	tRPHL	VD≥2.0V; Rise and fall time		50	200	ns
tRPLH-tRPHL	tsKEW2	VID≤15ns		13	15	ns
	SI	WITCHING CHARACTERISTI	CS OF DRIVER			
Driver Enable to Output High	tDzH	CL=100 pF, S1 closed			70	ns
Driver Enable to Output Low	tDzL	(Fig 5,6)			70	ns
Driver Disable Time from Low	tDLz	CL=15 pF, S2 closed			70	ns
Driver Disable Time from High	tDHZ	(Fig 5,6)			70	ns
Driver Propagation Delay(low to high)	tDPLH			60		ns
Driver Propagation Delay (high to low)	tDPHL	RDIFF=54Ω,		60		ns
tDPLH-tDPHL	tsKEW1	CLi=CL <sub>2</sub> =100pF (Fig 3,4)		5	±10	ns
Driver Differential Output Rise or Fall Time	tDR,tDF			40		ns



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS			
	SUPPLY CURRENT								
	lcc1	/RE=0V or VCC, DE=0V		200	500	uA			
Supply Current	Icc2	/RE=VCC, DE=VCC		300	600	uA			
	lcc₃	/RE=0, DE=VCC		0.5	10	uA			
	DC E	LECTRICAL CHARACTERISTIC	S OF RECEIVER						
Receiver Input Resistance	RN	-7V≤VcM≤12V	12			kΩ			
Receiver Output Short-Circuit	IosR	0V≤Vo≤VCC	±7		±95	mA			
RO Output-Low Voltage	VoL	IouT=+4mA, VID=-200 mV			0.4	V			
Three-State Output Current at Receiver	lozR	0.4V < Vo < 2.4V			±1	uA			
Receiver Input Hysteresis	Vhys	-7V≤VCM≤12V		30		mV			
RO Output-High Voltage	VoH	IoUT=-4mA, VID=+200 mV	3.5			V			
Positive-going input threshold voltage	VIT+	-7V≤VcM≤12V			-10	mV			
Negative-going input threshold voltage	VIT-	-7V≤VcM≤12V	-200			mV			
Install Comment (A.P.)	INO	DE=0V, VCC=0 or 5V			1.0	mA			
Input Current(A,B)	IN2	DE=0V, VCC=0 or 5V	0.8			mA			

NOTE

If no special situation occurs , VCC=5V $\pm$ 5% ,Temp=TMIN~TMAX , typically VCC=+5V , Temp = 25



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
DC ELECTRICAL CHARACTERISTICS OF DRIVER								
Input High Voltage	VH	DE,DI,/RE	2.0			V		
Input Low Voltage	Vn	DE,DI,/RE			0.8	V		
Input Current (RE,DI,/RE)	IN1	DE,DI,/RE	-2		2	uA		
Thermal-Shutdown Threshold				150		°C		
Thermal-Shutdown Hysteresis				20		°C		
Differential Driver Output(no load)	VoD1			5		V		
Differential Driver	VoD2	Fig 2,RL=27Ω	1.5		VCC	V		
Output		Fig 2,RL=50	2		VCC	V		
Change in Magnitude of Differential Output Voltage (NOTE1)	△VoD	Fig 2,RL=27Ω			0.2	V		
Driver Common-Mode Output Voltage	Voc	Fig 2,RL=27Ω			3	V		
Change In Magnitude of Common- Mode Voltage (NOTE1)	△Voc	Fig 2,RL=27Ω			0.2	V		
Driver Short-Circuit Output Current (short to high)	IosD <sub>1</sub>	Short to 0V~12V	35		250	mA		
Driver Short-Circuit Output Current (short to low)	losD2	Short to-7V~0V	-250		-35	mA		

## **TEST CIRCUIT**

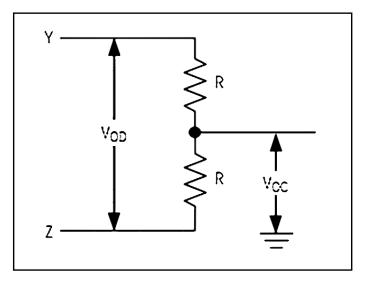


Fig 2 Driver DC Test Load

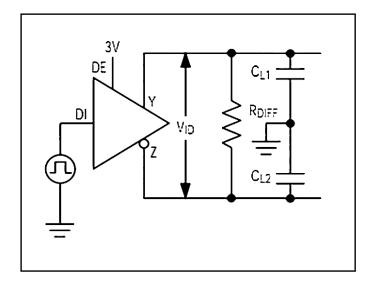
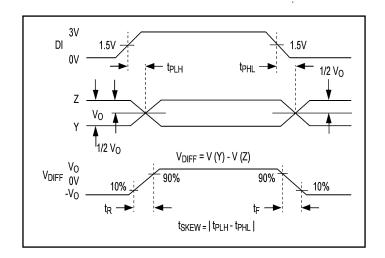


Fig 3 Driver Timing Test Circuit





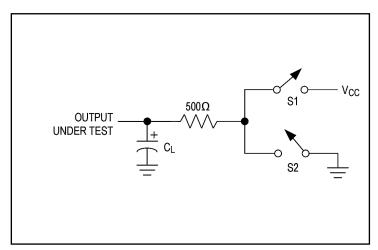


Fig 4 Driver Propagation Delays

Fig 5 Driver Enable/Disable Timing Test Load

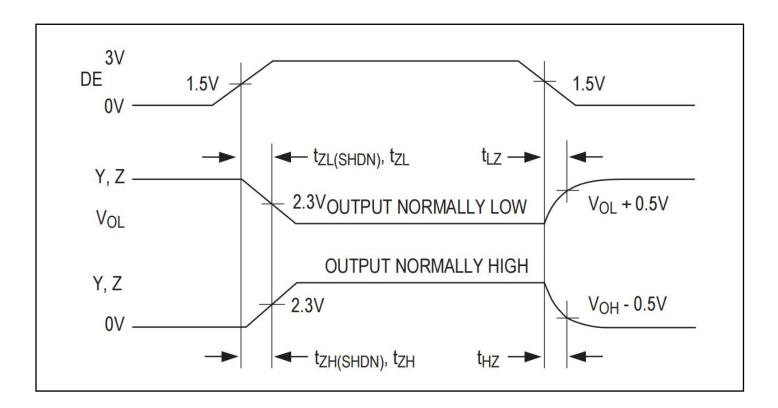


Fig 6 Driver Enable and Disable Times



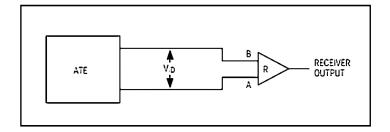


Fig 7Receiver Propagation Delay Test Circuit

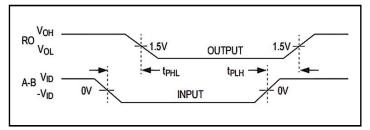
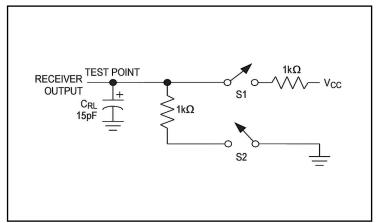


Fig 8 Receiver Propagation Delays



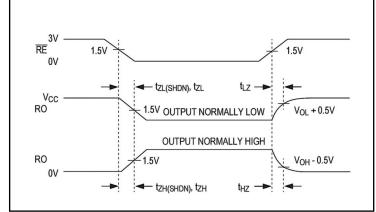


Fig 9 Receiver Enable/Disable Timing Test Load

Fig 10 Receiver Enable and Disable Times

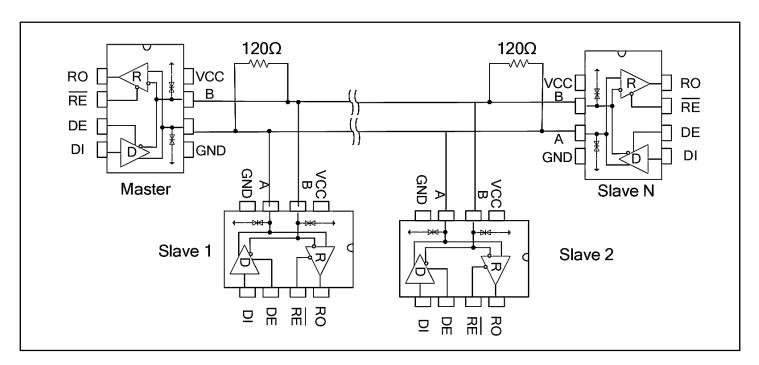


Fig11 Backbone cable type RS485 communications network



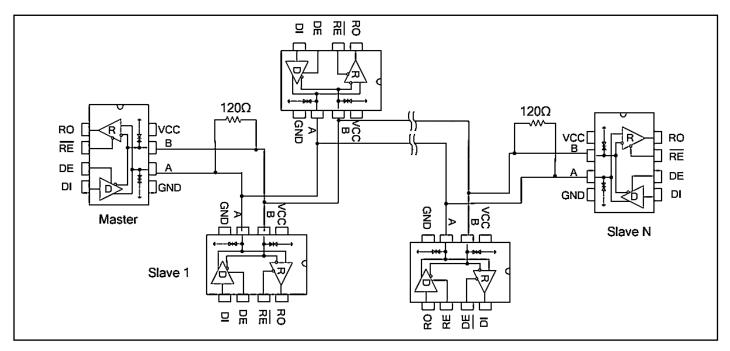


Fig12 Daisy chain topology type RS485 communications network

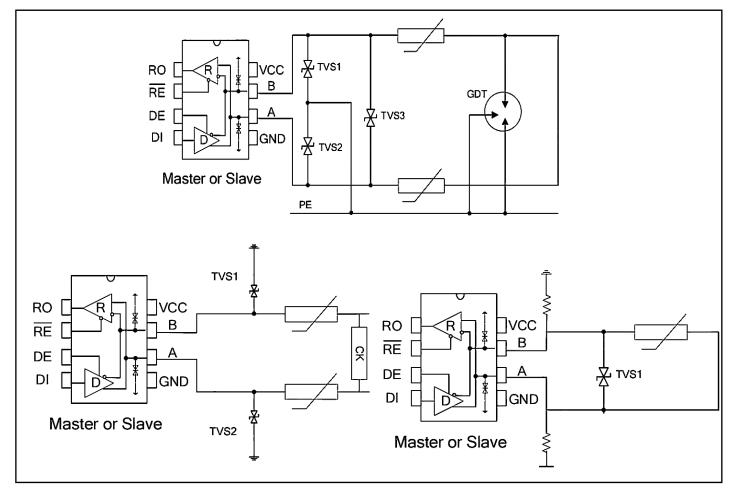


Fig13 RS485 bus ports Protection configuration



## Additional description

#### Description

1487, including a driver and a receiver, is a half-duplex high-speed transceivers for RS-485 / RS-422 communications. 1487 features fail-safe, overvoltage protection, overcurrent protection, thermal protection, and allows / RE, DE hot-swappable. The 1487 allows an error-free data transmission up to 2.5Mbps.

#### **Typical Application**

Backbone cable type: 1487 transceiver is designed for multi-point bi-directional data communication bus transmission lines. Figure 11 shows a typical network application circuit. These devices can also be used as a cable longer than 4,000 feet of line repeater, to reduce the reflection, the transmission line should be in its ends terminated in its characteristic impedance, and stub lengths off the main line should be as short as possible. Hand in hand type: Also known as daisy chain topology, is the prior RS485 bus topology recommended by the TIA organization. The routing method is the master device and a number of slave devices connected in hand-handle configuration, as shown in Figure 12. It' should be noted at that hand in handle means no branch line. This kind of topology has the advantages of small reflection and high rate of success communicationThe bus port protection: In harsh environments, RS485 communication ports are usually done with static protection, lightning surge protection, and other additional protection, even prepared to prevent 380V electricity access by mistake. To avoid the destruction of intelligent instruments and industrial control host, figure 13 demonstrates three general kinds of RS485 bus port protection configuration.

#### Connecting 32 Transceivers on one Bus

The standard 1487 receiver input impedance is guaranteed >12k , the standard driver can drive up to 32 unit loads. These devices can be any combination, or in combination with other RS-485 transceiver combination, as long as the total load does not load more than 32 units, can be connected on the same bus.

#### **Drive Output Protection**

Through two mechanisms to avoid failure or a bus contention causes power consumption is too high. First, in the entire common Mode voltage range, overcurrent protection circuit provides a fast short protection. Second, when the die temperature exceeds 150°C, driver output is forced into a high impedance state by the thermal shutdown circuit.

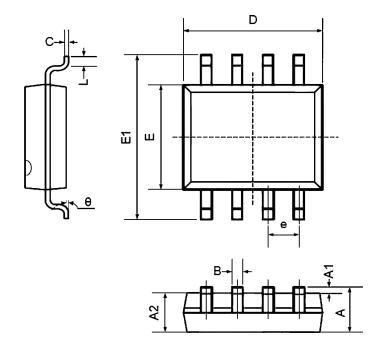
#### Fail Safe

When the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled, 1487 guarantees a logic-high receiver output. This is done by the receiver input thresholds are set between -10mV and -200mV. If the differential receiver input voltage (A-B) ≥-10mV, RO is logic high; if the voltage (A-B) ≤-200mV, RO is logic low. When attached to the terminal all transmitters on the bus are disabled, the receiver differential input voltage is pulled to 0V by the termination resistor. With the receiver threshold of the 1487, this results in a logic-high with a 10mV minimum noise margin. The -10mV to -200mV threshold complies with the ±200mV EIA/TIA-485 standard.



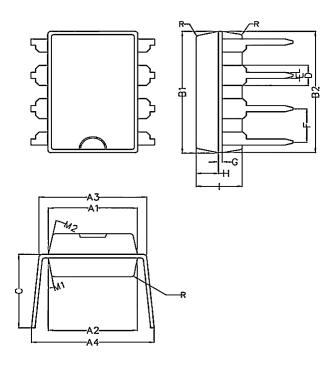
# Package Information

## SOP8



Symbol		nsions imeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
В	0.330	0.510	0.013	0.020	
С	0.190	0.250	0.007	0.010	
D	4.780	5.000	0.188	0.197	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.300	0.228	0.248	
е	1.27	1.270TYP		0ТҮР	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

## DIP8

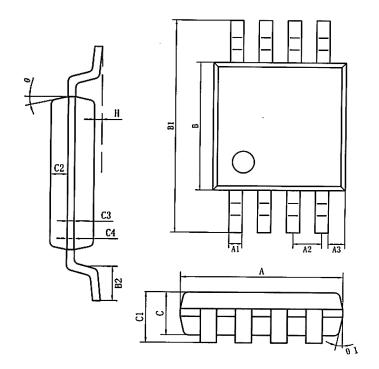


Symbol	Min	Non	Max
A1	6.28	6.33	6.38
A2	6.33	6.38	6.43
A3	7.52	7.62	7.72
A4	7.80	8.40	9.00
B1	9.15	9.20	9.25
B2	9.20	9.25	9.30
С		5.57	
D		1.52	
Е	0.43	0.45	0.47
F		2.54	
G		0.25	
Н	1.54	1.59	1.64
I	3.22	3.27	3.32
R		0.20	
M1	9°	10°	11°
M2	11°	12°	13°





## MSOP8



Symbol	Min/mm	Typ/mm	Max/mm		
	,	.,,,,,,,,,,			
Α	2.90	3.0	3.10		
A1	0.28		0.35		
A2		0.65typ			
А3		0.375typ			
В	2.90	3.0	3.10		
B1	4.70		5.10		
B2	0.45		0.75		
С	0.75		0.95		
C1			1.10		
C2	0.328typ				
C3	0.152				
C4	0.15		0.23		
Н	0.00		0.09		
θ	12°typ				

### Order information

Order Number	Package	Package Quantity	MarkingOn The park
MAX1487ESA-TUDI	SOP8	Tape,Reel,2500	MAX1487ESA
MAX1487EPA-TUDI	DIP8	Tube,50,A box of 2000	MAX1487EPA
MAX1487EUA-TUDI	MSOP8	Tape,Reel,2500	1487EUA



### Important statement:

- ●TUDI Semiconductor reserves the right to modify the product manual without prior notice! Before placing an order, customers need to confirm whether the obtained information is the latest version and verify the completeness of the relevant information.
- Any semi-guide product is subject to failure or malfunction under specified conditions. It is the buyer's responsibility to comply with safety standards when using TUDI Semiconductor products for system design and whole machine manufacturing. And take the appropriate safety measures to avoid the potential in the risk of loss of personal injury or loss of property situation!
- ●TUDI Semiconductor products have not been licensed for life support, military, and aerospace applications, and therefore TUDI Semiconductor is not responsible for any consequences arising from the use of this product in these areas.
- If any or all TUDI Semiconductor products (including technical data, services) described or contained in this document are subject to any applicable local export control laws and regulations, they may not be exported without an export license from the relevant authorities in accordance with such laws.
- The specifications of any and all TUDI Semiconductor products described or contained in this document specify the performance, characteristics, and functionality of said products in their standalone state, but do not guarantee the performance, characteristics, and functionality of said products installed in Customer's products or equipment. In order to verify symptoms and conditions that cannot be evaluated in a standalone device, the Customer should ultimately evaluate and test the device installed in the Customer's product device.
- ●TUDI Semiconductor documentation is only allowed to be copied without any alteration of the content and with the relevant authorization. TUDI Semiconductor assumes no responsibility or liability for altered documents.
- ●TUDI Semiconductor is committed to becoming the preferred semiconductor brand for customers, and TUDI Semiconductor will strive to provide customers with better performance and better quallity products.